

深圳市炬烜科技有限公司
CHIP SUN TECHNOLOGY CO., LTD

**APPROVAL
SHEET**



CUSTOMER: _____
DESCRIPTION: ZTTCR 8.000MHz SMD CERAMIC RESONATOR
MANUFACTURER PART NO.: ZTTCR8.00MG
CUSTOMER PART NO: _____
USED IN MODEL : _____

承 认 APPROVAL		
工程部 TECHNOLOGY DEPT.	品质部 QUALITY DEPT.	采购部 PURCHASING DEPT.

Date: June 24, 2020



深圳市炬烜科技有限公司

CHIP SUN TECHNOLOGY CO., LTD

地址 ADD: 深圳市龙华新区大浪腾龙路淘金地电子商务孵化基地 B 座 206
Rm. Rm 206, Tower B, Taojindi Building, Tenglong Road, Dalang Street,
Longhua New District, Shenzhen, China

电话 TEL: 86-755-83458796 传真 FAX: 86-755-83459818

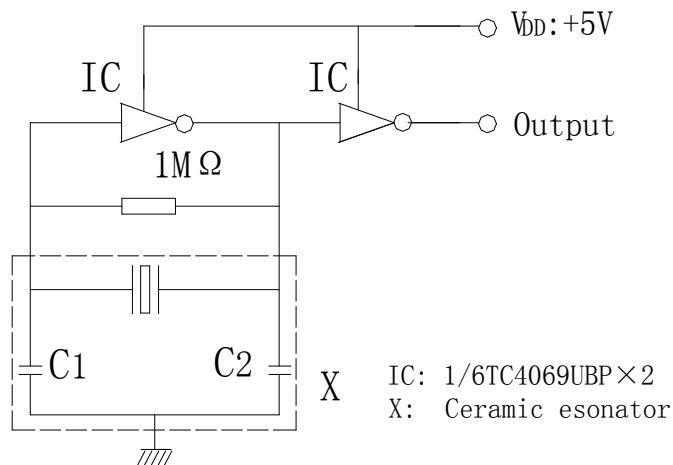
网址 WEB ADD: <http://www.chinachipsun.com>

E-MAIL: sales01@chinachipsun.com

<p>1. Scope:</p> <p>The specification shall cover of SMD ceramic resonator with 8.000MHz used for oscillation circuit</p> <p>2. Spec. No.: 20180829-2</p> <p>3. Part No.: ZTTCR8.00MG</p> <p>4. Electrical Characteristics</p> <p>4.1 Nominal Frequency</p> <p>4.2 Frequency Tolerance</p> <p>4.3 Resonant Resistance</p> <p>4.4 Build-in Capacitance</p> <p>4.5 Temperature Stability (-40°C~+85°C)</p> <p>4.6 Insulation Resistance</p> <p>4.7 Aging</p> <p>4.8 Aging for 10 years</p> <p>4.9 Withstanding Voltage</p> <p>4.10 Max Voltage</p> <p>DC</p> <p>AC</p> <p>4.11 Operating Temperature</p> <p>4.12 Storage Temperature</p> <p>5 Measurement</p> <p>5.1 Measurement Condition</p> <p>Measurement shall be carried out at the standard temperature of $25 \pm 2^\circ\text{C}$, and humidity $55 \pm 5\%$ under normal air pressure. If no specific requirements, Test can be carried out under $5\text{-}35^\circ\text{C}$, and humidity 45-65%.</p> <p>5.2 Measuring Circuit and Equipment</p> <p>Nominal frequency shall be measured by the standard test circuit as shown in Fig.1, Resonant Resistance shall be measured by network analyzer.</p>	<p>8.000MHz</p> <p>$\pm 0.5\%$max</p> <p>40Ω max</p> <p>33pF</p> <p>$\pm 0.3\%$ max</p> <p>5$\times 10^8\Omega$ min (10V, 1min)</p> <p>$\pm 0.1\%$ max(From initial value)</p> <p>$\pm 0.3\%$ max(From initial value)</p> <p>100V_{DC} 5 sec max</p> <p>6V_{DC}</p> <p>15V_{P-P}</p> <p>-40°C~+85°C</p> <p>-45°C~+85°C</p>
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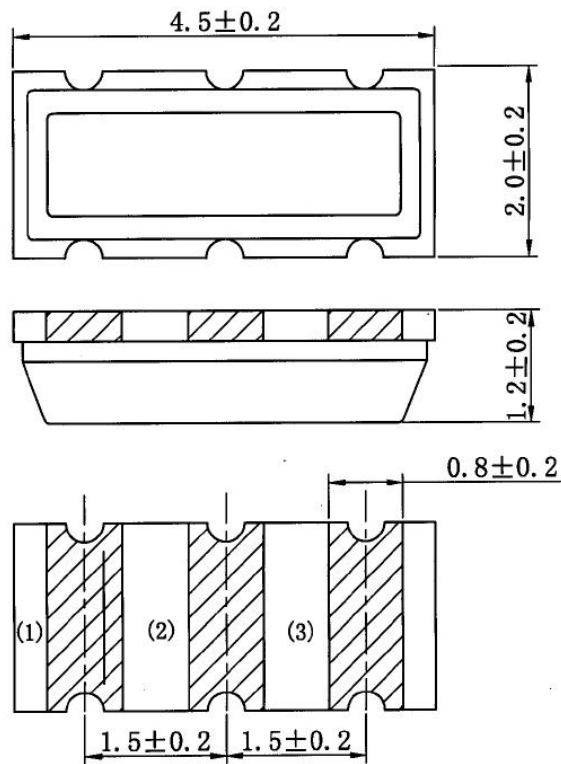
DESCRIPTION	SMD CERAMIC RESONATOR ZTTCR 8.00MHZ $\pm 0.5\%$
DATE	June 24, 2020



6. Outline

6.1 Appearance: Mark shall be clear; appearance shall be smooth and no damage.

6.2 Dimensions:



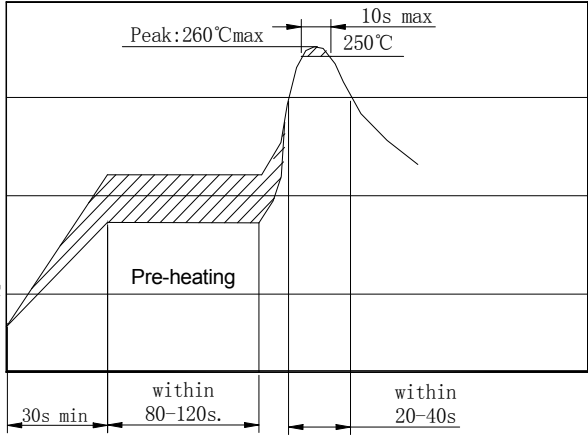
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<p>7. Physical Characteristics</p> <p>7.1 Random Drop</p> <p>7.2 Vibration</p> <p>7.3 Solder ability</p>	<p>Resonator shall be measured after 3 times random frops from the height of 1.0mm on wooden floor</p> <p>Resonator shall be measured after being applied vibration of amplitude of 1.5mm with 10-55Hz band of vibration frequency to each of 3 perpendicular directions for 2 hours</p> <p>The electrode of resonator are immersed in aide solder for 5scc and then immersed in soldering bath of $230\pm 5^{\circ}\text{C}$, for $3\pm 0.5\text{scc}$.</p>	<p>No visible damage and it meet Table 1</p> <p>No damage and it meet Table 1.</p> <p>At least 95% electrode shall be covered with solder.</p>
<p>8. Environmental Characteristics</p> <p>8.1 Humidity</p> <p>8.2 Resistance to Solder Heat</p> <p>(1) Reflow solder</p> <p>(2) Solder by Iron</p>	<p>After being placed in a chamber with 90-95%R.H.at $60\pm 2^{\circ}\text{C}$ for 100 hours and then being placed in room temperature for 1 hour, resonator shall be measured.</p> <p>After resonator is soldered for 1 time in following temperature conditions, and then be placed in natural condition for 24-25 hours. Resonator shall be measured.</p>  <p>Resonator is soldered at $280\pm 5^{\circ}\text{C}$ for $3\pm 0.5\text{sec}$. Then be placed in natural condition for 24 hours, Iron do not touch resonator while soldering.</p>	<p>It shall meet Table 1</p> <p>No visible damage and it meet Table 1.</p> <p>No visible damage and it meet Table 1.</p>

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8.3 High Temperature	After being placed in a chamber with 85±2℃ for 100 hours and then being placed in room temperature for 1 hour, resonator shall be measured.	It shall meet Table1
8.4 Low Temperature	After being placed in a chamber with -40±2℃ for 100 hours and then being placed in room temperature for 1 hour, resonator shall be measured.	It shall meet Table1
8.5 Heat Shock	After being kept at room temperature, resonator shall be placed at temperature of -55℃.for 30 minutes, then be placed at temperature.85℃.for 30 minutes. After that returned to -55℃ again. Repeated above cycle for 5times. After being kept in room temp.for 1 hour, resonator shall be measured.	It shall meet Table1

Table 1

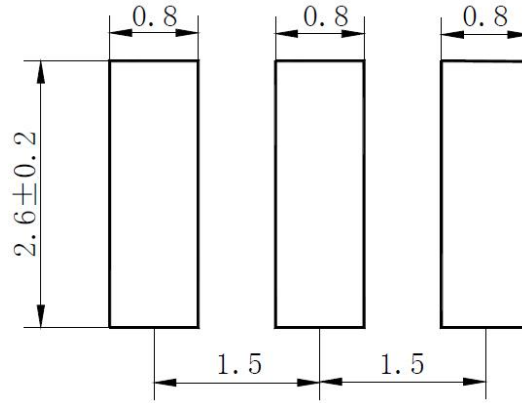
Item	Variation
Oscillation Frequency	±5% Max. (Please refer to initial value)
Resonant Resistance	40 Ω Max.

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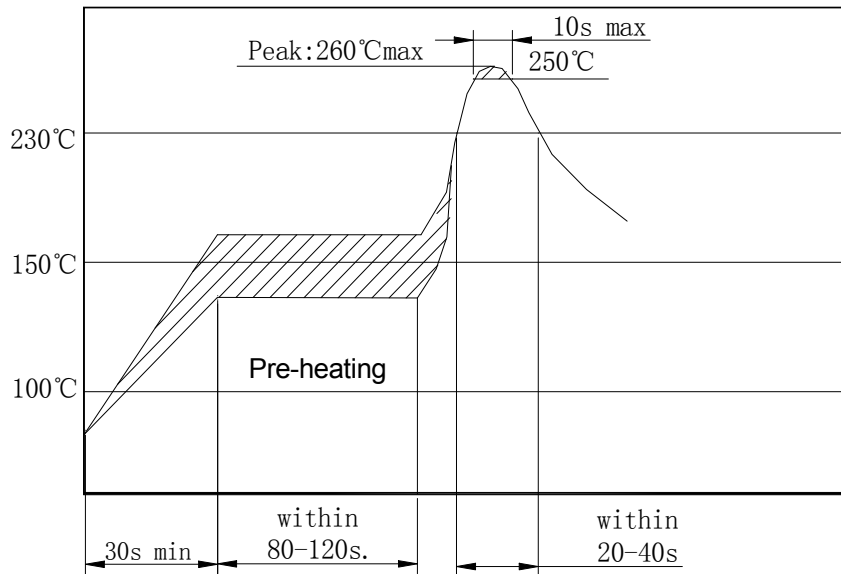
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9 RECOMMENDED LAND PATTERN AND REFLOW SOLDERING STANDARD CONDITIONS

9.1 Recommended land pattern



9.2 Recommended reflow soldering standard conditions



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